

Fig. 1a: Embodiment of a Lead Frame Panel (Prior Art)

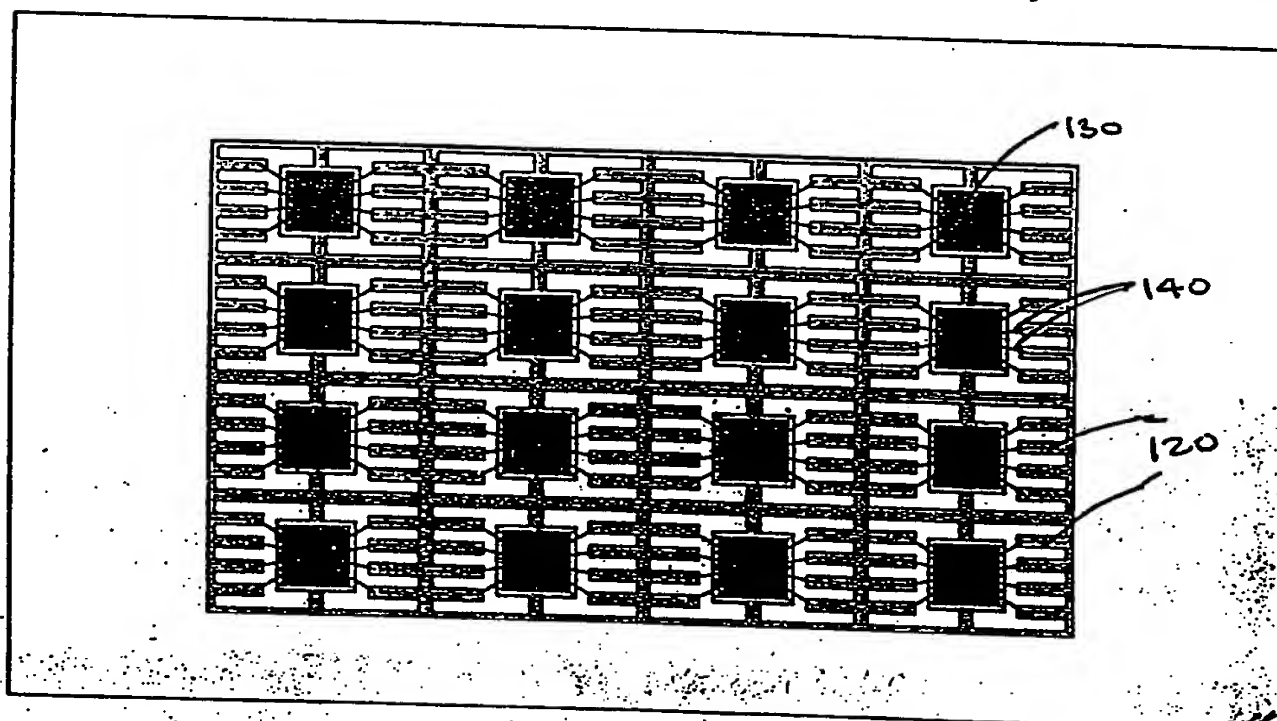


Fig. 1b: Lead Frame with IC Chips Attached (Prior Art)

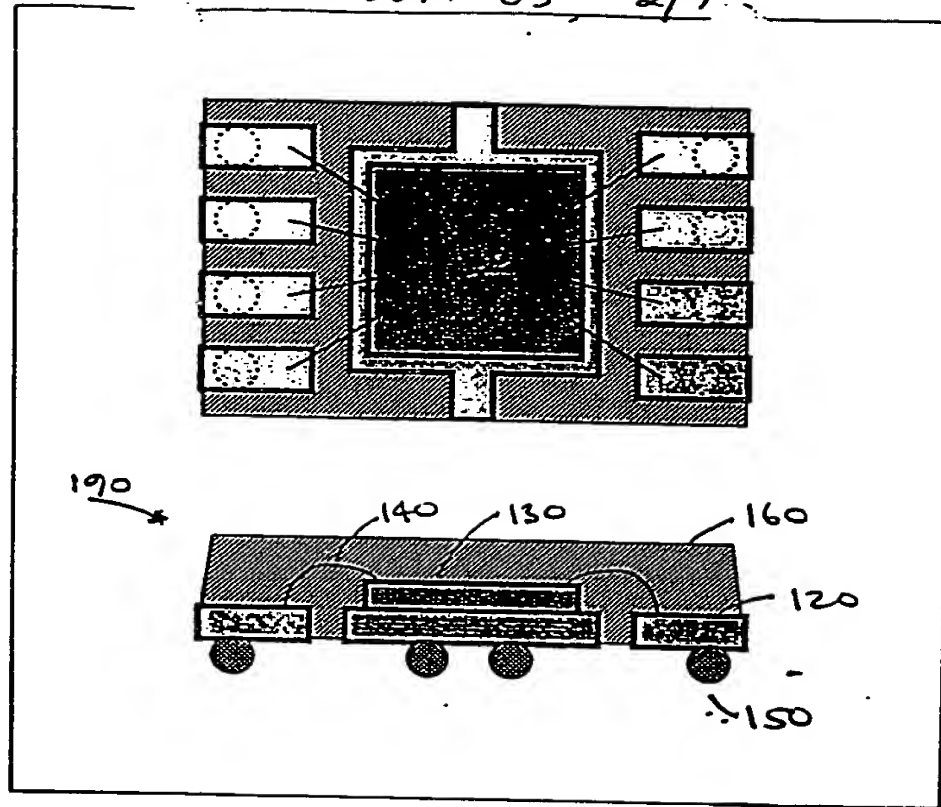


Fig. 1c: Finished BGA IC Package

~~(PENDING)~~